



**THE DATASHEET OF
DMG1029SVQ-7**



Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
Q1	60V	1.7Ω @ V _{GS} = 10V	500mA
		3Ω @ V _{GS} = 4.5V	400mA
Q2	-60V	4Ω @ V _{GS} = -10V	-360mA
		6Ω @ V _{GS} = -4.5V	-310mA

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface-Mount Package
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The DMG1029SVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

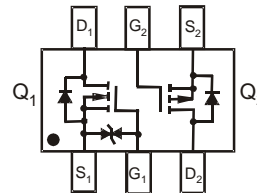
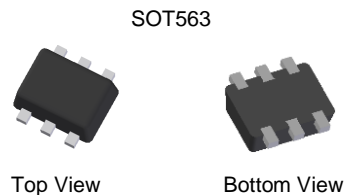
Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- General-purpose interfacing switches
- Power-management functions
- Analog switches

Mechanical Data

- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 **e3**
- Weight: 0.027 grams (Approximate)

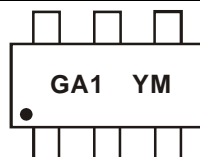


Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
DMG1029SVQ-7	SOT563	3000	Tape & Reel
DMG1029SVQ-7A	SOT563	3000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>

Marking Information



GA1 = Product Type Marking Code
 YM = Date Code Marking
 Y or \bar{Y} = Year (ex: K = 2023)
 M = Month (ex: 9 = September)

Date Code Key

Year	2021	...	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	I	...	K	L	M	N	P	R	S	T	U	V

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	60	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	I _D	T _A = +25°C T _A = +70°C	500 400	mA
	t < 10s		T _A = +25°C T _A = +70°C	620 480	mA
Maximum Body Diode Forward Current (Note 6)		I _S	500	mA	
Pulsed Drain Current (Note 6)		I _{DM}	1000	mA	
Pulsed Source Current (Note 6)		I _{SM}	1000	mA	

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-60	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	I _D	T _A = +25°C T _A = +70°C	-360 -280	mA
	t < 10s		T _A = +25°C T _A = +70°C	-410 -320	mA
Maximum Body Diode Forward Current (Note 6)		I _S	-360	mA	
Pulsed Drain Current (Note 6)		I _{DM}	-650	mA	
Pulsed Source Current (Note 6)		I _{SM}	-650	mA	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	0.45	W
	T _A = +70°C		0.28	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{θJA}	281	°C/W
	t < 10s		210	
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	1	W
	T _A = +70°C		0.62	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{θJA}	129	°C/W
	t < 10s		97	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

Electrical Characteristics N-CHANNEL – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	60	—	—	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	—	—	10	nA	V _{DS} = 50V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±50	nA	V _{GS} = ±5V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.0	—	2.5	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	—	1.3	1.7	Ω	V _{GS} = 10V, I _D = 500mA
		—	1.5	3		V _{GS} = 4.5V, I _D = 200mA
Forward Transfer Admittance	Y _{FS}	80	—	—	mS	V _{DS} = 10V, I _D = 200mA
Diode Forward Voltage	V _{SD}	—	—	1.4	V	V _{GS} = 0V, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	—	30	—	pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	—	4.2	—	pF	
Reverse Transfer Capacitance	C _{rss}	—	2.9	—	pF	
Total Gate Charge	Q _g	—	0.3	—	nC	V _{GS} = 4.5V, V _{DS} = 10V, I _D = 250mA
Gate-Source Charge	Q _{gs}	—	0.2	—	nC	
Gate-Drain Charge	Q _{gd}	—	0.08	—	nC	
Turn-On Delay Time	t _{D(ON)}	—	3.9	—	ns	V _{DD} = 30V, V _{GS} = 10V, R _G = 25Ω, I _D = 200mA
Turn-On Rise Time	t _r	—	3.4	—	ns	
Turn-Off Delay Time	t _{D(OFF)}	—	15.7	—	ns	
Turn-Off Fall Time	t _f	—	9.9	—	ns	

Electrical Characteristics P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-60	—	—	V	V _{GS} = 0V, I _D = -250μA
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}	—	—	-25	nA	V _{DS} = -50V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±5V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-1	—	-3.0	V	V _{DS} = V _{GS} , I _D = -250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	—	2.7	4	Ω	V _{GS} = -10V, I _D = -500mA
		—	3.2	6		V _{GS} = -4.5V, I _D = -200mA
Forward Transfer Admittance	Y _{FS}	50	—	—	mS	V _{DS} = -25V, I _D = -100mA
Diode Forward Voltage	V _{SD}	—	—	-1.4	V	V _{GS} = 0V, I _S = -115mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	—	25	—	pF	V _{DS} = -25V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	—	4.7	—	pF	
Reverse Transfer Capacitance	C _{rss}	—	2.7	—	pF	
Total Gate Charge	Q _g	—	0.28	—	nC	V _{GS} = -4.5V, V _{DS} = -10V, I _D = -500mA
Gate-Source Charge	Q _{gs}	—	0.14	—	nC	
Gate-Drain Charge	Q _{gd}	—	0.08	—	nC	
Turn-On Delay Time	t _{D(ON)}	—	5.5	—	ns	V _{DD} = -30V, V _{GS} = -10V, R _G = 50Ω, I _D = -270mA
Turn-On Rise Time	t _r	—	7.9	—	ns	
Turn-Off Delay Time	t _{D(OFF)}	—	10.6	—	ns	
Turn-Off Fall Time	t _f	—	11.6	—	ns	

Notes: 7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

N-CHANNEL – Q1

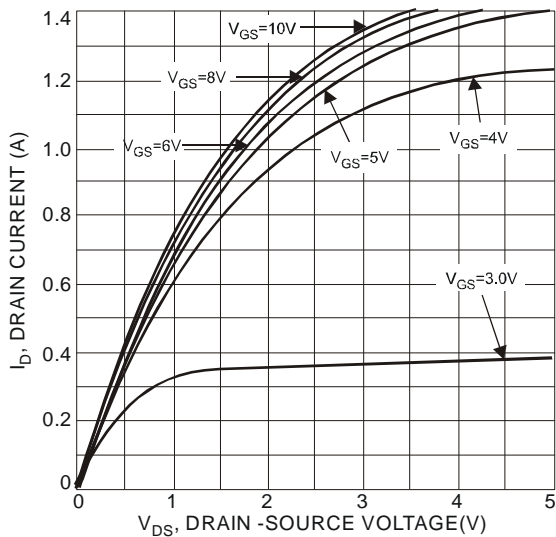


Fig. 1 Typical Output Characteristics

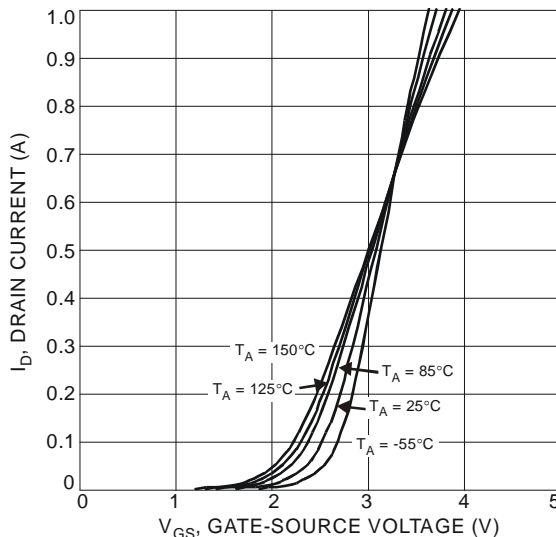


Fig. 2 Typical Transfer Characteristics

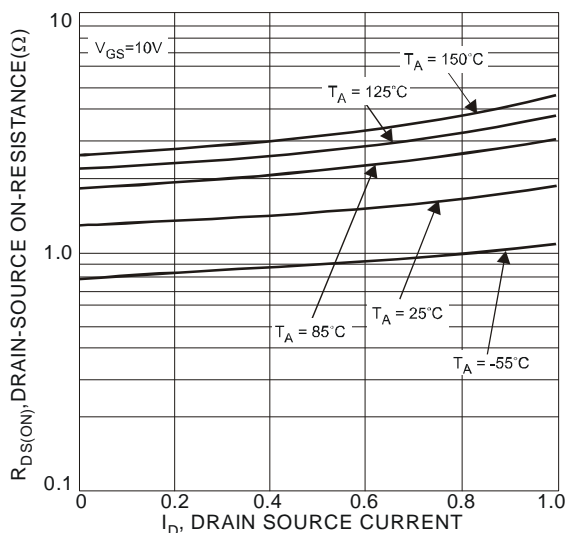


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

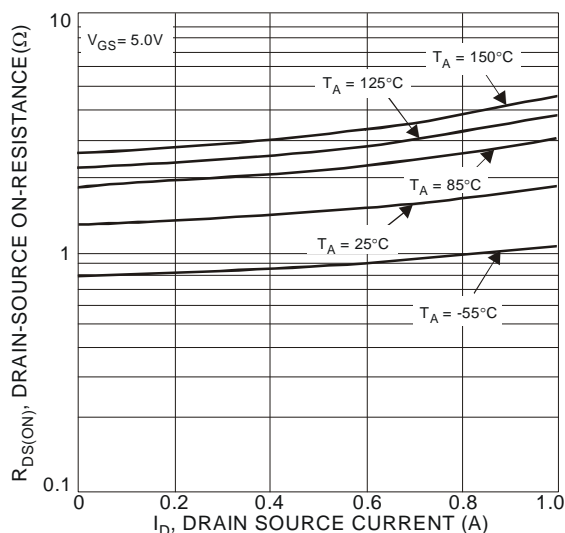


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

N-CHANNEL – Q1 (continued)

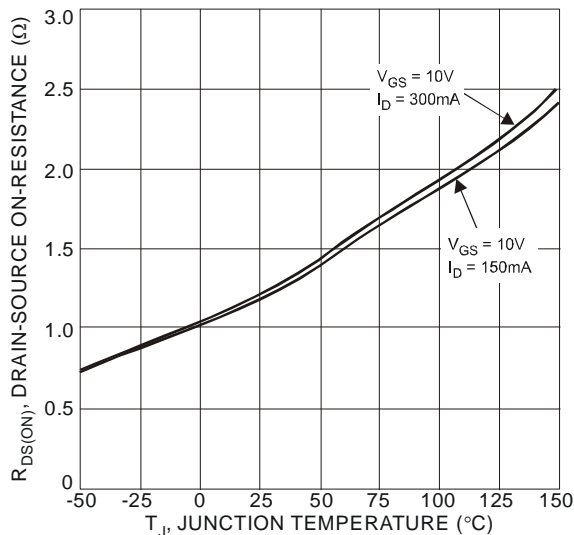


Fig. 5 On-Resistance Variation with Temperature

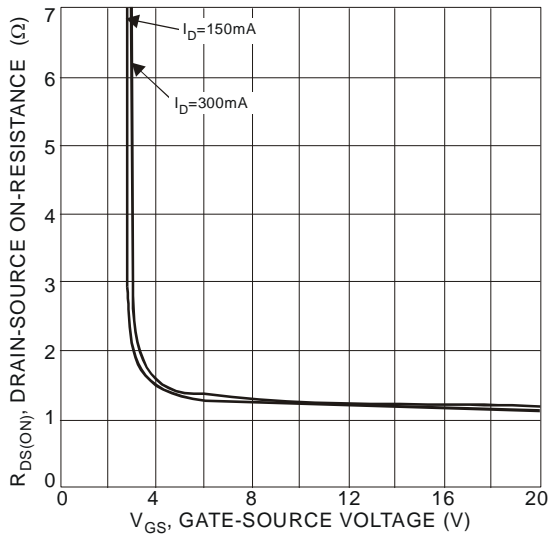


Fig. 6 Static Drain-Source On-Resistance vs. Gate-Source Voltage

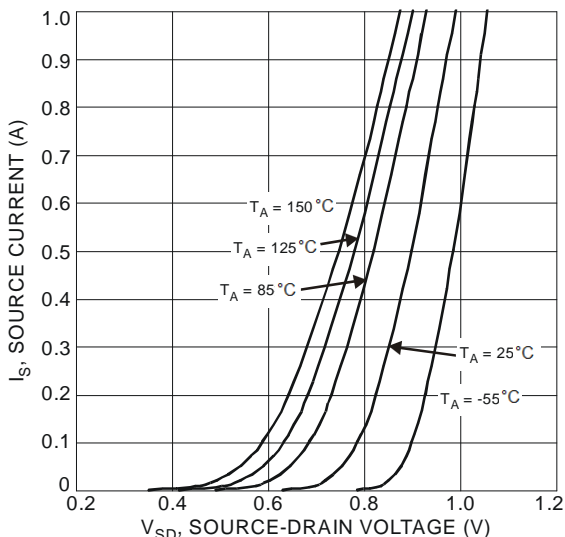


Fig. 7 Diode Forward Voltage vs. Current

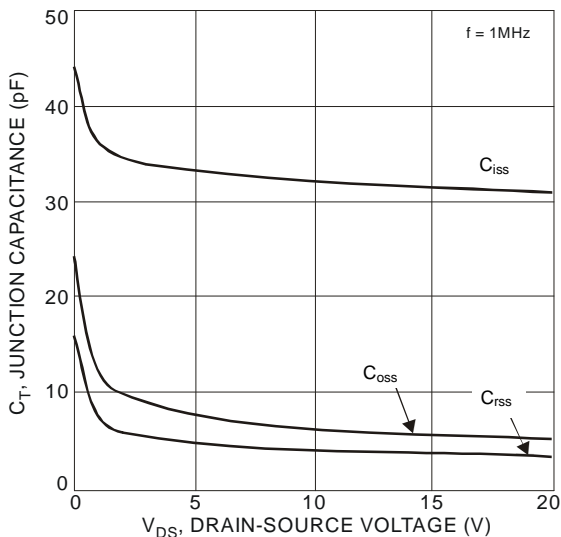
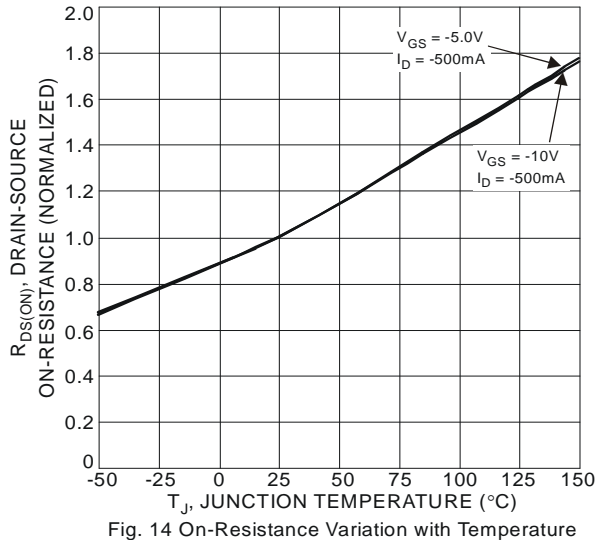
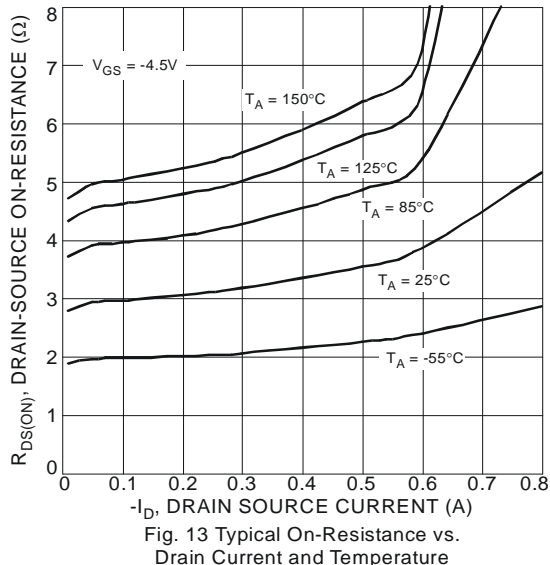
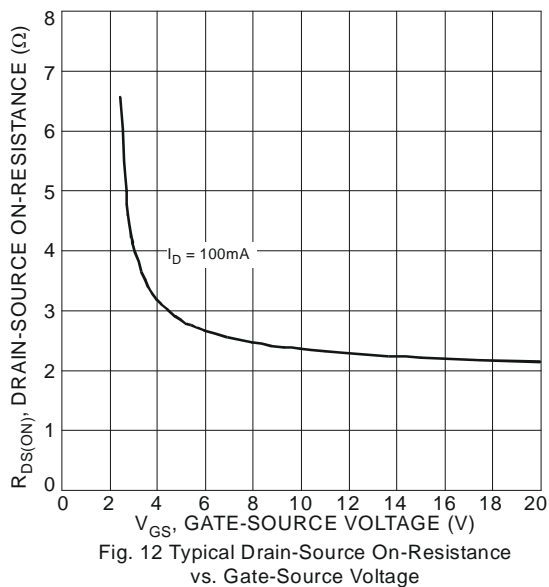
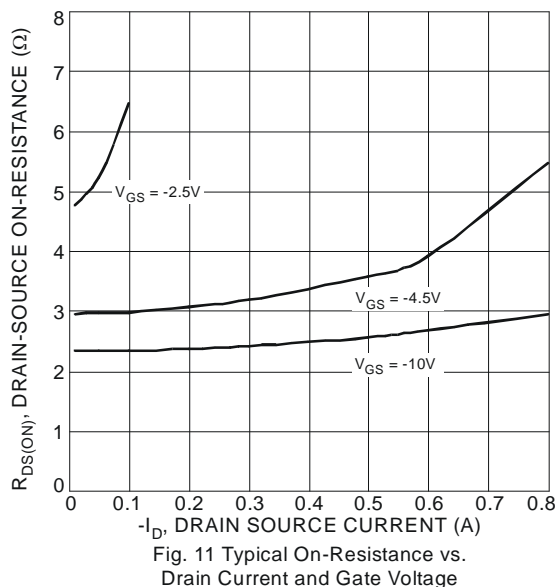
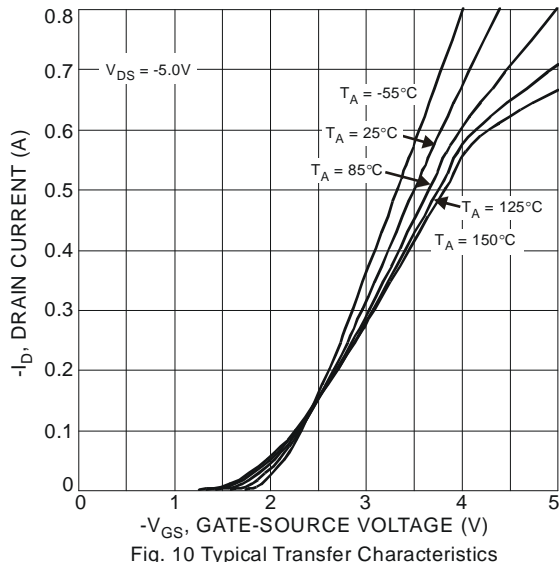
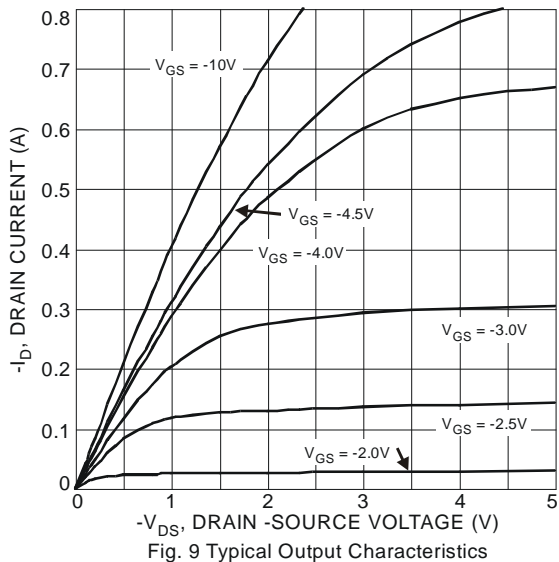


Fig. 8 Typical Junction Capacitance

P-CHANNEL – Q2



P-CHANNEL – Q2 (continued)

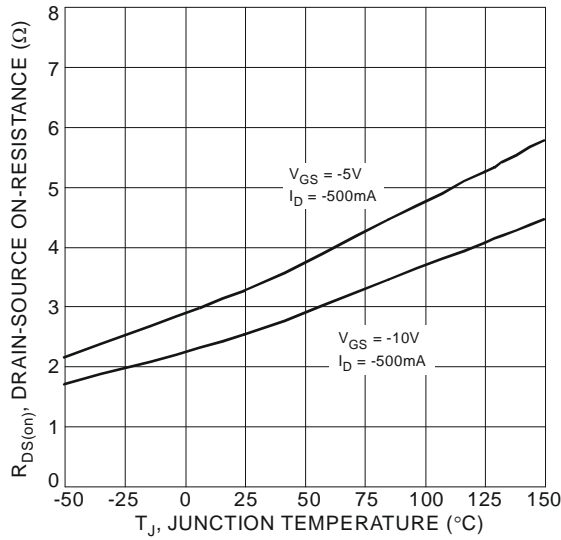


Fig. 15 On-Resistance Variation with Temperature

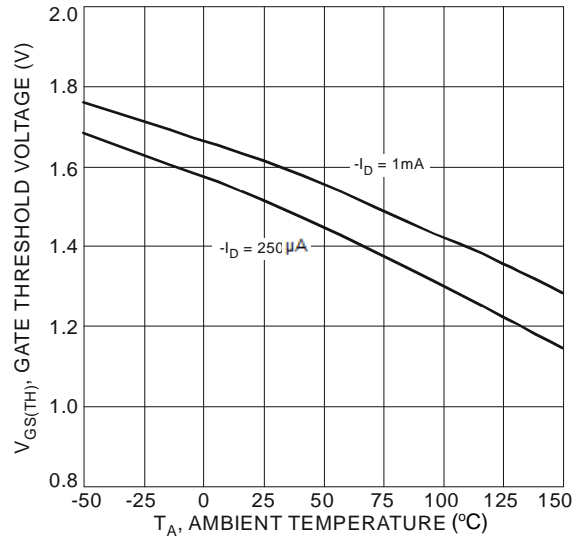


Fig. 16 Gate Threshold Variation vs. Ambient Temperature

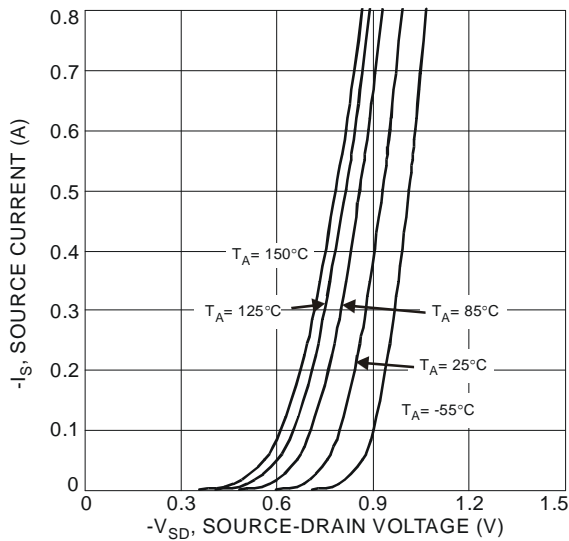


Fig. 17 Diode Forward Voltage vs. Current

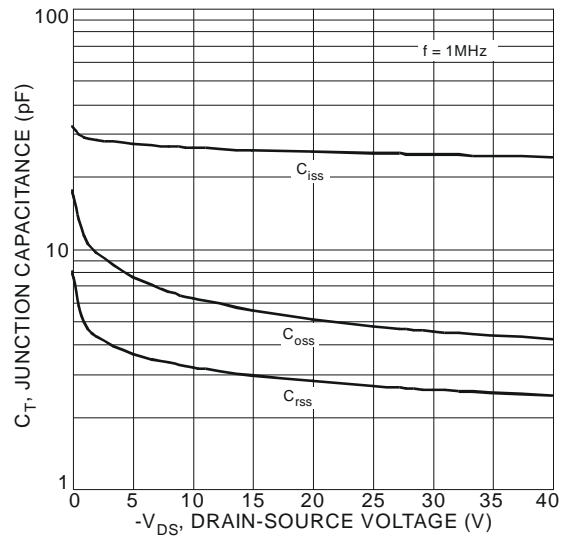


Fig. 18 Typical Junction Capacitance

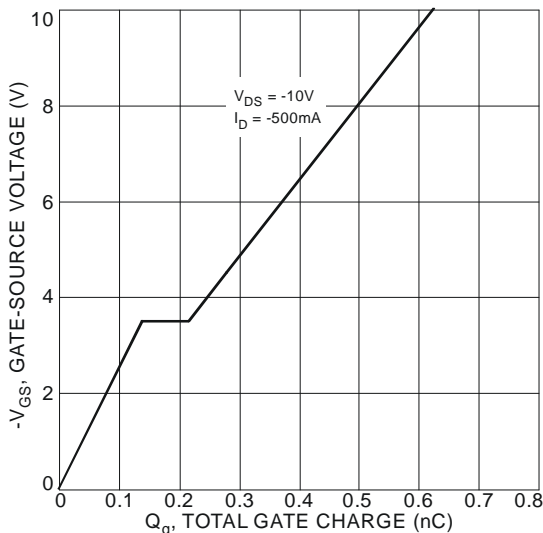
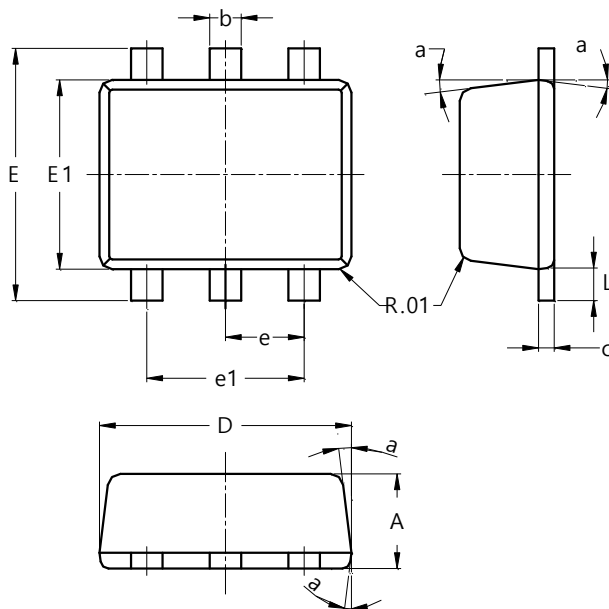


Fig. 19 Gate-Charge Characteristics

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563

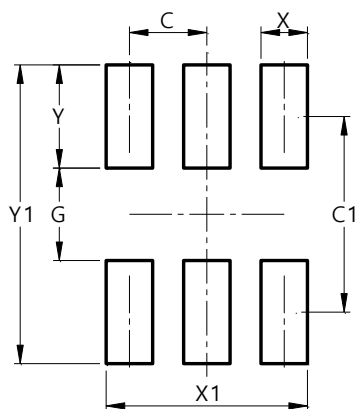


SOT563			
Dim	Min	Max	Typ
A	0.55	0.60	--
b	0.15	0.30	0.20
c	0.10	0.18	0.11
D	1.50	1.70	1.60
E	1.55	1.70	1.60
E1	1.10	1.25	1.20
e	--	--	0.50
e1	0.90	1.10	1.00
L	0.10	0.30	0.20
a	8°	9°	7°
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT563



Dimensions	Value (in mm)
C	0.500
C1	1.270
G	0.600
X	0.300
X1	1.300
Y	0.670
Y1	1.940

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